

AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Claims 1-11 (cancelled).

12. (currently amended) A coating method comprising:

(a) providing a substrate including a deposition region and an optional uncoated region, wherein the deposition region includes a level intermediate region disposed between a first end region and a second end region,

wherein the first end region includes a first recessed surface portion that increases the surface area of the first end region, wherein the first recessed surface portion is recessed below the level intermediate region, wherein the first recessed portion is non-detachable from the substrate ~~the surface area of the first end region is greater by at least about 5% than the surface area of a hypothetical level first end region;~~

(b) dip coating a layer of a coating solution over the first end region, the intermediate region, and the second end region in the recited sequence wherein the layer is not separated from the substrate.

13. (original) The method of claim 12, wherein the substrate is a cylinder.

14. (original) The method of claim 12, wherein the first recessed surface portion includes at least one groove.

15. (original) The method of claim 12, wherein the first recessed surface portion includes a tapered surface.

16. (original) The method of claim 12, wherein the first recessed surface portion includes a stepped area.

17. (original) The method of claim 12, wherein the dip coated layer comprises a charge transport material.

Claim 18 (cancelled).

Claim 19 (cancelled).

20. (original) The method of claim 12, wherein the portion of the dip coated layer over the first end region is substantially level.